



## Product Change Notice

Title	Change Notice for 16G Dual Channel CompactFlash Modules
Affected Products	CF-DC-G-16G-I all variations
PCN#	12-0002
Date	July 20, 2012

### Summary:

Due to a die shrink by Samsung, WinSystems will be modifying the visible disk size of our dual-channel CF-DC-G-16G-I CompactFlash modules and changing the NAND FLASH manufacturer to Toshiba. The Toshiba NAND FLASH is equal to Samsung in speed, durability and temperature range.

### Impact:

Customers may need to rebuild their master CompactFlash images to accommodate the change in size.

### WinSystems Products Affected

The affected products are summarized in the table below where "xx" is the variant number:

Part Number	Description	Replacement
CF-DC-G-16G-I	16G industrial CompactFlash	CF-DC-A-16G-I

**Effective Date:** July 20, 2012

**Recommended Action:** Contact your WinSystems' Applications Engineer to start the re-qualification process.

**Last Time Buy Schedule:** Remaining inventory will be sold on a first-come-first serve basis

**Last Time Ship Schedule:** NC/NR Blanket orders will be accepted with a last ship date not to exceed 12/15/2013

### Questions Concerning this change:

Contact your WinSystems' Applications Engineer. Phone: 817-274-7553

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